

IEEE P802.3dj 200 Gb/s, 400 Gb/s, 800 Gb/s, and 1.6 Tb/s Ethernet Task Force

Unapproved Meeting Minutes, prepared by John D'Ambrosia, Mark Nowell, Gary Nicholl, and Kent Lusted

July 2026 Session: 13 July 2026 Co-located Interim Meetings and July 2026 Plenary meeting.

13 July 2026 - Co-located Interim meeting

Location: Montreal, Quebec, Canada

IEEE P802.3dj Task Force Meeting Page - https://www.ieee802.org/3/dj/public/26_07/index.html

Session called to order at 8:03 a.m. Eastern Daylight Time (EDT) by John D'Ambrosia, Chair of the P802.3dj Task Force.

Chair reminded participants to declare their name and affiliation in the online meeting tool. Failure to declare would result in expulsion from the meeting.

Chair reminded participants that participation in the 13 July 2026 co-located interim meeting does not require registration or payment of registration fee. The meeting will not count towards IEEE 802.3 Working Group voting membership. (see Agenda slide #1)

If participants are not eligible to sign in to IMAT to claim attendance credit, please send an email to the Task Force Chair and Recording Secretary to be recorded in the minutes as an attendee.

Agenda:

Title	Agenda and General Information
Presenters	John D'Ambrosia
URL	https://www.ieee802.org/3/dj/public/26_07/agenda_3dj_b_2607.pdf

Chair asked if there were any objections to the agenda. There were none. The agenda was considered approved by unanimous consent.

Chair noted that there were several Task Force and ad hoc meeting minutes to approve (see slide #5)

- May 2026 Interim – https://www.ieee802.org/3/dj/public/26_05/minutes_3dj_2605_unapproved.pdf
- Joint Ad hoc (Electrical / Optic / Logic) – 24 June 2026
https://www.ieee802.org/3/dj/public/adhoc/optics/0626_OPTX/minutes_3dj_optx_elec_logic_260624_unapproved.pdf
- Annex 178B –
 - 03 June 2026
https://www.ieee802.org/3/dj/public/adhoc/178b/26_0603/minutes_178b_a_260603_unapproved.pdf
 - 25 June 2026
https://www.ieee802.org/3/dj/public/adhoc/178b/26_0625/minutes_178b_260625_unapproved.pdf

Chair asked if there were any corrections or modifications to the posted minutes. No one responded. Chair asked if there were any objections to approving the minutes. There were none, and the minutes were considered approved by unanimous consent.

Chair reviewed meeting decorum. (See Slide #6-9) Chair asked if there were any members of the press present. No one responded.

Chair reviewed the goals for the session (see slide #10).

Chair reviewed the Task Force Project Information / Organization for the P802.3dj Task Forces. (See Slides #12).

Chair reviewed ground rules. (See Slide #14)

Chair reviewed voting in the task force. (see slide #15) Chair noted that the straw polls would use the online meeting tool. Motions would be taken with the Direct Vote Live tool if there was not unanimous consent. Chair noted that he reserved the right to take informative straw polls by 802.3 WG voting membership.

Chair reviewed the update membership and attendance recording requirements (see slide #16-17).

Chair noted that he would be reporting individuals signing into IMAT that did not meet the eligibility requirements.

Slide #18 - Chair noted that the information regarding the IEEE SA Policies had been sent out via the Task Force reflector , and requested that individuals review the following IEEE SA policies prior to the interim meeting –

- IEEE SA Patent policy
- IEEE SA Copyright Policy
- IEEE SA Participation Policy and IEEE Code of Ethics

Chair asked if anyone needed to review the policies at that time – there were no requests to do so from in-person nor remote attendees.

Chair presented the third slide (See Slide #45) of the IEEE SA Patent Policy slides. Chair did call for Potentially Essential Patents, and no one came forward.

Chair presented the second slide (See Slide #50) of the IEEE SA Copyright Policy slides. Chair noted – “By participating in this activity, you agree to comply with the IEEE Code of Ethics, all applicable laws, and all IEEE policies and procedures including, but not limited to, the IEEE SA Copyright Policy.”

Chair reminded participants of the IEEE Code of Ethics and Conduct. (See slide #53) He noted “All participants in IEEE-SA activities are expected to adhere to the core principles underlying the IEEE Code of Ethics and IEEE Code of Conduct”.

Chair presented the second slide (See Slide #54) of the IEEE SA Participation Policy slides. Chair noted – “Participants in the IEEE-SA “individual process” shall act independently of others, including employers. By participating in standards activities using the “individual process”, you are deemed to accept these requirements; if you are unable to satisfy these requirements then you shall immediately cease any participation.”

Chair presented the third slide (See Slide #55) of the IEEE SA Participation Policy. Chair noted that IEEE-SA standards activities should allow the fair & equitable consideration of all viewpoints, and The IEEE-SA Standards Board Bylaws (clause 5.2.1.3) specifies that “the standards development process shall not be dominated by any single interest category, individual, or organization”.

Chair reviewed the liaison responses and liaisons for consideration by the Task Force at the meeting. (see Agenda slide #19). He noted that two liaisons were received over the weekend from the ITU-T. Chair noted that the recommendation from Tom Huber was that no response was necessary.

Chair reviewed the ad hoc reports.

Kent Lusted reviewed the joint electrical/logic/optical ad hoc report. (see: https://www.ieee802.org/3/dj/public/26_07/lusted_3dj_01_2607.pdf)

John D'Ambrosia reviewed the Annex 178B ad hoc report (see: https://www.ieee802.org/3/dj/public/26_07/dambrosia_3dj_01_2607.pdf). He reviewed the straw polls taken in the ad hoc meeting.

Chair reviewed the Timeline Going Forward (see agenda starting on slide 21). He reviewed the requirements to complete IEEE SA ballot. He noted that all of the comments would need to be resolved during the plenary week to meet the noted timeline, which had also been stated in the the PAR extension request.

Chair advised participants that the Task Force would likely run late on Tuesday and Wednesday night.

IMAT Reminder:

8:49 a.m. Chair reminded the room that this meeting required registration and payment of registration fee.

Chair asked that eligible participants should sign in to IMAT to claim Working Group attendance credit. He noted that participants not eligible to sign in to IMAT to claim Working Group attendance credit are to send an email to John D'Ambrosia / Kent Lusted to be recorded in the meeting minutes. He paused for a minute to let eligible attendees sign into IMAT. He asked if there was any eligible participant having a problem signing into IMAT. No one responded.

Chief Editor Report:

Title	Editor's Report
Presenters	Matt Brown
URL	https://www.ieee802.org/3/dj/public/26_07/brown_3dj_01_2607.pdf

Comment Agenda:

Title	Comment Agenda
Presenters	Matt Brown
URL	https://www.ieee802.org/3/dj/public/26_07/brown_3dj_02_2607.pdf

Questions were asked and answered. Chief Editor noted that there was a potential bucket2 based on revised responses to bucket1 pull requests or comments pointing back to comments closed during the week.

Bucket1 Pull Summary

Kent Lusted noted that he sent a summary of the requests to pull comments from the P802.3dj D3.1 bucket1 received before the deadline. (see <https://www.ieee802.org/3/B400G/email/msg01929.html>) John D'Ambrosia provided the list of bucket1 pull requests to participants. He asked participants if there were any additional bucket1 pull requests. No one responded.

Chair noted that motions would be taken with the Direct Vote Live tool if there was not unanimous consent. Chair asked if there would be opposition to attempt the vote by unanimous consent. No one responded.

Motion 1: bucket1	Move to: Adopt the proposed responses for P802.3dj D3.1 comment resolution in 'bucket1' https://www.ieee802.org/3/dj/comments/D3p1/8023dj_D3p1_comments_proposed_id_bucket1.pdf except comment # 15, 62, 67, 80, 83, 84, 89, 92, 118, 124, 137, 144, 171, 176, 177, 196, 207, 217, 221, 224, 226, 250, 251, 252, 260, 262, 273, 275, 296, 297, 305
Technical (>= 75%)	
Moved by	Matt Brown
Second by	Adee Ran
Results 802.3 (y/n/a)	Passed by unanimous consent. 9:18 a.m.

Chair reviewed the status of the non-ballot (late) comments and provided an overview of how they would be handled during comment resolution. He noted that only the non-ballot comments considered by the CRG would be entered into the IEEE SA comment database for D3.1. The non-ballot comments were posted at https://www.ieee802.org/3/dj/comments/D3p1/8023dj_D3p1_Non-BallotComments_Adee_Ran_Redacted.pdf

Chair noted that motions would be taken with the Direct Vote Live tool if there was not unanimous consent. Chair asked if there would be opposition to attempt the vote by unanimous consent.

Motion 2: non-ballot comments	Move to consider the non-ballot (late) comments in https://www.ieee802.org/3/dj/comments/D3p1/8023dj_D3p1_Non-BallotComments_Adee_Ran_Redacted.pdf during the P802.3dj Draft 3.1 comment resolution cycle, if time permits.
Technical (>= 75%)	
Moved by	Adee Ran
Second by	Leon Bruckman
Results 802.3 (y/n/a)	Passed by unanimous consent. 9:26 a.m.

Chair noted that motions would be taken with the Direct Vote Live tool if there was not unanimous consent. Chair asked if there would be opposition to attempt the vote by unanimous consent.

There was opposition.

Motion 3: late preso	Move to consider the late presentations ran_03 and daw_01 during the P802.3dj Draft 3.1 comment resolution cycle, if time permits.
Technical (>= 75%)	
Moved by	Adee Ran
Second by	Norm Swenson
Results 802.3 (y/n/a)	y: 28, n: 14, A: 5 motion fails. 9:34 a.m.

Motion #3 votes:

Attendee	Vote
Adee Ran	Yes
Andras De Koos	Yes
Cathy Liu	Yes
Charles Moorwood	Yes
David Lewis	No
David Ofelt	Yes
Eric Bernier	No
Eric Maniloff	Yes
Flavio Marques	Yes
Gary Landry	No
Gyudong Kim	Yes
Hansel Dsilva	Yes
Hormoz Djahanshahi	Yes
James Weaver	Abstain
Jeff Slavick	Abstain
John Johnson	No
Jose Galan	No
Karlheinz Muth	No
Leon Bruckman	Yes
Marco Mascitto	No
Mark Nowell	No
Matthew Brown	No
Michael Wingrove	Yes
Mike-Peng Li	Abstain
Mohammad Shakiba	No

Attendee	Vote
Norman Swenson	Yes
Oluwafemi Akinwale	Yes
Pei-Rong Li	Abstain
Peter Wu	Yes
Piers J G Dawe	Yes
Richard Mellitz	No
Rick Rabinovich	No
Sam Kocsis	No
Scott Sommers	Yes
Shawn Nicholl	Yes
Shimon Muller	Yes
Stephane Lessard	Yes
Thomas Huber	Yes
Toshiaki Sakai	Yes
Ulf Parkholm	Yes
Upen Kareti	Yes
Viet Tran	Yes
Wenxiong Xu	Yes
William Simms	No
Xiang He	Yes
Xuebo Wang	Abstain
Yuki Murakami	Yes

Comment resolution began at 9:38 a.m. John D'Ambrosia passed the comment resolution responsibilities to Kent Lusted and Matt Brown.

Task Force Chair noted that the AM1 session had a hard stop at 10:00 a.m. local time.

Task Force Chair reminded participants that the 10 minute restriction on presentations will be enforced by the TF leadership.

Meeting recessed at 9:59 a.m. eastern.

13 July 2026 – Task Force Meeting

Session resumed at 1:21 p.m. Eastern Daylight Time (EDT) by John D'Ambrosia, Chair of the P802.3dj Task Force.

Chair reminded participants to declare their name and affiliation in the online meeting tool. Failure to declare would result in expulsion from the meeting.

Chair noted that every attendee at the IEEE 802.3 Plenary meeting (Face-to-Face or Remote) must register and pay a fee to participate. (see slide #1 of agenda)

If participants are not eligible to sign in to IMAT to claim attendance credit, please send an email to the Task Force Chair and Recording Secretary to be recorded in the minutes as an attendee.

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- IEEE Code of Ethics
- IEEE Code of Conduct

Comment resolution resumed at 1:26 p.m.

Chief Editor reviewed the plan for the afternoon. He noted that the CRG might address electrical topics if the progress is quicker than expected.

Chair announced that the updated comment agenda version 02b was posted to the website for participants.

IMAT Reminder:

1:53 p.m. Chair reminded the room that this meeting required registration and payment of registration fee.

Chair asked that eligible participants should sign in to IMAT to claim Working Group attendance credit. He noted that participants not eligible to sign in to IMAT to claim Working Group attendance credit are to send an email to John D'Ambrosia / Kent Lusted to be recorded in the meeting minutes. He paused for a minute to let eligible attendees sign into IMAT. He asked if there was any eligible participant having a problem signing into IMAT. No one responded.

PM Break

Break at 3:00 p.m. Resumed at 3:30 p.m.

Presentation #TF-1:

Title	Why probability of less than 1e-11 is not necessary for AUI links
Presenters	Mike Dudek
URL	https://www.ieee802.org/3/dj/public/26_07/dudek_3dj_01_2607.pdf

Questions were asked and answered.

Prior to the start of presentation TF-2, the author noted there was an updated version 04a with an additional explanatory slide. Chair asked if there was objection to hearing the updated slide. No one responded.

Presentation #TF-2:

Title	Projecting BLER for AUIs
Presenters	Adee Ran
URL	https://www.ieee802.org/3/dj/public/26_07/ran_3dj_04a_2607.pdf

Questions were asked and answered.

IMAT Reminder:

4:11 p.m. Chair reminded the room that this meeting required registration and payment of registration fee.

Chair asked that eligible participants should sign in to IMAT to claim Working Group attendance credit. He noted that participants not eligible to sign in to IMAT to claim Working Group attendance credit are to send an email to John D'Ambrosia / Kent Lusted to be recorded in the meeting minutes. He paused for a minute to let eligible attendees sign into IMAT. He asked if there was any eligible participant having a problem signing into IMAT. No one responded.

Straw Poll TF-1

(See comment #R1-201)

Straw Poll TF-2

(See comment #R-201)

Adee Ran withdrew non-ballot comment marked "L06".

During the discussion of the non-ballot late comments, Chief Editor noted that he would work with the Working Group Vice Chair on the wording to capture in the response for the time permitted and consensus.

Adee Ran withdrew non-ballot comment marked "L02".

Straw Poll TF-3

(see non-ballot comment #L04)

I support making changes in the direction proposed in the suggested remedy of non-ballot comment L04.

Y: 14

N: 13

Adee Ran withdrew non-ballot comment marked "L04".

The CRG discussed the status of comments R1-188 and R1-220. Participants acknowledged that they were actively working on consensus building toward a solution. The CRG leadership deferred comments R1-188 and R1-220 until Thursday AM1 and assigned Jeff Slavick, Adee Ran and Luz Osorio to prepare a consensus presentation. There would be 15 minutes to show the proposal to the CRG on Thursday.

Chair noted that the progress was reasonable on Monday. He noted that "closed as of" comment reports would be posted by tomorrow.

Chair reminded participants of the deferred resolution of comments R1-188 and R1-220.

Chair reminded participants of the IEEE 802 tutorial on liaison communications on Monday evening.

Chair reminded participants that the APSU for Coherent topic would be tentatively discussed for Tuesday PM2 to allow P802.3dt to complete their work.

Meeting recessed for the day at 5:59 p.m.

14 July 2026 – Electrical Track

Session called to order at 8:18 a.m. Eastern Daylight Time (EDT) by Kent Lusted, Electrical Track Chair of the P802.3dj Task Force.

Chair reminded participants to declare their name and affiliation in the online meeting tool. Failure to declare would result in expulsion from the meeting.

Chair noted that every attendee at the IEEE 802.3 Plenary meeting (Face-to-Face or Remote) must register and pay a fee to participate. (see slide #1 of agenda)

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Comment resolution resumed at 8:26 a.m.

IMAT Reminder:

8:47 a.m. Chair reminded the room that this meeting required registration and payment of registration fee.

Chair asked that eligible participants should sign in to IMAT to claim Working Group attendance credit. He noted that participants not eligible to sign in to IMAT to claim Working Group attendance credit are to send an email to John D'Ambrosia / Kent Lusted to be recorded in the meeting minutes. He paused for a minute to let eligible attendees sign into IMAT. He asked if there was any eligible participant having a problem signing into IMAT. No one responded.

Presentation #E-1:

Title	C2M module R_peak (comment 240)
Presenters	Alex Rysin
URL	https://www.ieee802.org/3/dj/public/26_07/rysin_3dj_01a_2607.pdf

During Q&A, the author noted that slide 4 had data that used the partial host channel and that the rise time was approximately 6-7 ps. He would update the contribution to version 01a to add these notes on slide 4.

AM Break

Break at 10:09 a.m. Resumed at 10:39 a.m.

Presentation #E-2:

Title	Mated Test Fixture Insertion Loss (Comment #149)
Presenters	Howard Heck
URL	https://www.ieee802.org/3/dj/public/26_07/heck_3dj_01_2607.pdf

IMAT Reminder:

11:10 a.m. Chair reminded the room that this meeting required registration and payment of registration fee.

Chair asked that eligible participants should sign in to IMAT to claim Working Group attendance credit. He noted that participants not eligible to sign in to IMAT to claim Working Group attendance credit are to send an email to John D'Ambrosia / Kent Lusted to be recorded in the meeting minutes. He paused for a minute to let eligible attendees sign into IMAT. He asked if there was any eligible participant having a problem signing into IMAT. No one responded.

Howard Heck withdrew comment #R1-149.

Adee Ran withdrew non-ballot comment marked “L07”.

Chair reminded participants of the afternoon plans and the common optical topics.

Meeting recessed for the day at 11:40 a.m. EDT.

14 July 2026 – Optical Track

Session called to order at 8:10 a.m. Eastern Daylight Time (EDT) by Mark Nowell, Optical Track Chair of the P802.3dj Task Force.

Chair reminded participants to declare their name and affiliation in the online meeting tool. Failure to declare would result in expulsion from the meeting.

Chair noted that every attendee at the IEEE 802.3 Plenary meeting (Face-to-Face or Remote) must register and pay a fee to participate. (see slide #1 of agenda)

If participants are not eligible to sign in to IMAT to claim attendance credit, please send an email to the Task Force Chair and Recording Secretary to be recorded in the minutes as an attendee.

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Chair noted that another late presentation has been submitted (Dawe_02). This contribution has been posted and the TF will consider whether to review it during Wednesday's meeting.

Chair noted that Ahmad El-Chayeb is unable to participate due to the arrival of a new baby (Congratulations Ahmad!). His co-author, David Leyba has been granted permission to join the meeting. Pursuant to the IEEE 802 LMSC Operations Manual Section 5, IEEE 802.3 Working Group Chair David Law designated David Leyba as an individual expert who was allowed to participate in Working Group discussions via electronic means during an in-person meeting for the benefit of the group. These individuals are not considered to be attending the meeting and so they are not required to pay meeting fees and they do not get participation credit. The participation of David Leyba would be limited to to give Ahmad El-Chayeb's presentation, support the discussion regarding the presentation, as well as the discussion of the relevant comments.

The chair shared the logistics for the next two days. At lunch, the room will be reconfigured back into a big room. A new dial-in bridge will be sent out to be used for the afternoon session.

The session will continue at 7:30pm local time after a dinner break at 6pm local time. An end time is not being indicated at this time.

The chair also noted that we have secured meeting room availability for after the social on Wednesday if it is needed. The chair encouraged the group to try to move quickly through the comment resolution as he expects no one is going to be keen to have to use that Wednesday evening meeting time.

Comment resolution resumed at 8:25 a.m.

David Lewis withdrew comment #R1-191,192, 193, 194.

Presentation #O-1:

Title	Supporting information for comments on transmitter power excursion
Presenters	John Johnson
URL	https://www.ieee802.org/3/dj/public/26_07/johnson_3dj_01_2607.pdf

Questions were asked and answered.

Presentation #O-2:

Title	TFT Examples & Illustrations
Presenters	Chris Cole
URL	https://www.ieee802.org/3/dj/public/26_07/cole_3dj_01a_2607.pdf

The Chair confirmed with the presenter that the co-authors agreed with the proposed comment responses from the editorial team for the comments listed on slide 3 of Cole_01a. The chair indicated that he viewed this as a strong indication of consensus and support for the relevant proposed responses which should speed up our comment resolution.

IMAT Reminder:

9:30 a.m. Chair reminded the room that this meeting required registration and payment of registration fee.

Chair asked that eligible participants should sign in to IMAT to claim Working Group attendance credit. He noted that participants not eligible to sign in to IMAT to claim Working Group attendance credit are to send an email to John D'Ambrosia / Kent Lusted to be recorded in the meeting minutes. He paused for a minute to let eligible attendees sign into IMAT. He asked if there was any eligible participant having a problem signing into IMAT. No one responded.

Presentation #O-3:

Title	Editorial Team Comment Resolution - Optical Topics
Presenters	Tom Issenhuth
URL	https://www.ieee802.org/3/dj/public/26_07/issenhuth_3dj_01b_2607.pdf

Note: These slides contained proposed editorial resolutions to various comments as they arise. Refer to the comment report to see the specific slides that were reviewed against specific comments as each instance is not captured in these minutes. Multiple versions of these slides are posted on the [meeting page](#) but the latest version above includes all the slides that were used in the meeting.

AM Break

Break at 10:00 a.m. Resumed at 10:22 a.m.

IMAT Reminder:

11:30 a.m. Chair reminded the room that this meeting required registration and payment of registration fee.

Chair asked that eligible participants should sign in to IMAT to claim Working Group attendance credit. He noted that participants not eligible to sign in to IMAT to claim Working Group attendance credit are to send an email to John D'Ambrosia / Kent Lusted to be recorded in the meeting minutes. He paused for a minute to let eligible attendees sign into IMAT. He asked if there was any eligible participant having a problem signing into IMAT. No one responded.

Lunch Break

Break at 12:00 p.m. Resumed at 1:27 p.m.

Chair outlined the plans for the afternoon. He noted that the CRG would close the TDECQ related comments before ending the day. He encouraged folks to continue to build consensus and efficiently close the comments.

Presentation #O-4:

Title	TDECQ Calculation Method
Presenters	David Leyba
URL	https://www.ieee802.org/3/dj/public/26_07/chayeb_3dj_01_2607.pdf

IMAT Reminder:

2:10 p.m. Chair reminded the room that this meeting required registration and payment of registration fee. Chair asked that eligible participants should sign in to IMAT to claim Working Group attendance credit. He noted that participants not eligible to sign in to IMAT to claim Working Group attendance credit are to send an email to John D'Ambrosia / Kent Lusted to be recorded in the meeting minutes. He paused for a minute to let eligible attendees sign into IMAT. He asked if there was any eligible participant having a problem signing into IMAT. No one responded.

PM Break

Break at 3:25 p.m. Resumed at 3:45 p.m.

Presentation #O-5:

Title	TDECQ Calculation according to D3.1
Presenters	Norm Swenson
URL	https://www.ieee802.org/3/dj/public/26_07/swenson_3dj_01a_2607.pdf

Straw Poll TF-4

(see comment reports)

Norm Swenson withdrew comment #R1-226, 263, 264, 267

IMAT Reminder:

4:55 p.m. Chair reminded the room that this meeting required registration and payment of registration fee. Chair asked that eligible participants should sign in to IMAT to claim Working Group attendance credit. He noted that participants not eligible to sign in to IMAT to claim Working Group attendance credit are to send an email to John D'Ambrosia / Kent Lusted to be recorded in the meeting minutes. He paused for a minute to let eligible attendees sign into IMAT. He asked if there was any eligible participant having a problem signing into IMAT. No one responded.

Evening Break

Break at 5:58 p.m. Resumed at 7:40 p.m.

Presentation #O-6:

Title	Ceq Definition and Limit
Presenters	Mark Kimber
URL	https://www.ieee802.org/3/dj/public/26_07/kimber_3dj_01_2607.pdf

Straw Poll TF-5

(see comment #R1-79)

Straw Poll TF-6

(see comment #R1-195)

Norm Swenson withdrew comment #R1-224.

Presentation #O-7:

Title	Capturing Jitter Penalty During TDECQ and TFSEH Tests
Presenters	Ali Ghiasi
URL	https://www.ieee802.org/3/dj/public/26_07/ghiasi_3dj_02_2607.pdf

Straw Poll #TF-7

(see comment #R1-154)

Ali Ghiasi withdrew comment #R1-159.

Presentation #O-8:

Title	Improved Definition of CRU
Presenters	Ali Ghiasi
URL	https://www.ieee802.org/3/dj/public/26_07/ghiasi_3dj_01a_2607.pdf

Ali Ghiasi withdrew comment #R1-151, R1-152, and R1-153.

Chair reminded participants of the starting time for Wednesday and its dependence on the IEEE 802.3 400 Gb/s/lane signaling study group. The 3dj would start in the IMAT session after the B400 Study Group ended.

Meeting recessed for the day at 11:17 p.m. EDT.

14 July 2026 – Logic Track

Session called to order at 8:10 a.m. Eastern Daylight Time (EDT) by Gary Nicholl, Logic Track Chair of the P802.3dj Task Force.

Chair reminded participants to declare their name and affiliation in the online meeting tool. Failure to declare would result in expulsion from the meeting.

Chair noted that every attendee at the IEEE 802.3 Plenary meeting (Face-to-Face or Remote) must register and pay a fee to participate. (see slide #1 of agenda)

If participants are not eligible to sign in to IMAT to claim attendance credit, please send an email to the Task Force Chair and Recording Secretary to be recorded in the minutes as an attendee.

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- IEEE Code of Conduct

Comment resolution started at 8:13 a.m.

IMAT Reminder (AM1):

09:06 a.m. Chair reminded the room that this meeting required registration and payment of registration fee.

Chair asked that eligible participants should sign in to IMAT to claim Working Group attendance credit. He noted that participants not eligible to sign in to IMAT to claim Working Group attendance credit are to send an email to John D'Ambrosia / Kent Lusted to be recorded in the meeting minutes. He paused for a minute to let eligible attendees sign into IMAT. He asked if there was any eligible participant having a problem signing into IMAT. No one responded.

Presentation #L-01:

Title	Path data delay through the n:m SM-PMA
Presenters	Andras de Koos
URL	https://www.ieee802.org/3/dj/public/26_07/dekoos_3dj_01_2607.pdf

Questions were asked and answered.

Tom Huber withdrew comment R1-137.

Leon Bruckman withdrew comment R1-67.

AM Break

Break at 10:05 a.m. Resumed at 10:31 a.m.

IMAT Reminder (AM2):

10:53 a.m. Chair reminded the room that this meeting required registration and payment of registration fee.

Chair asked that eligible participants should sign in to IMAT to claim Working Group attendance credit. He noted that participants not eligible to sign in to IMAT to claim Working Group attendance credit are to send an email to John D'Ambrosia / Kent Lusted to be recorded in the meeting minutes. He paused for a minute to let eligible attendees sign into IMAT. He asked if there was any eligible participant having a problem signing into IMAT. No one responded.

Chair made closing remarks.

Meeting recessed at 10:55 a.m. EDT.

15 July 2026 – Task Force

Session called to order at 10:18 a.m. Eastern Daylight Time (EDT) by John D'Ambrosia, Chair of the P802.3dj Task Force.

Chair reminded participants to declare their name and affiliation in the online meeting tool. Failure to declare would result in expulsion from the meeting.

Chair noted that every attendee at the IEEE 802.3 Plenary meeting (Face-to-Face or Remote) must register and pay a fee to participate. (see slide #1 of agenda)

If participants are not eligible to sign in to IMAT to claim attendance credit, please send an email to the Task Force Chair and Recording Secretary to be recorded in the minutes as an attendee.

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- IEEE Code of Conduct

Comment resolution resumed at 10:25 a.m.

Presentation #TF-3:

Title	RTS FSM for coherent PMDs
Presenters	Tom Huber
URL	https://www.ieee802.org/3/dj/public/26_07/huber_3dj_01a_2607.pdf

Questions were asked and answered.

Presentation #TF-4:

Title	Supporting materials for comment R1-169
Presenters	Jeff Slavick
URL	https://www.ieee802.org/3/dj/public/26_07/slavick_3dj_01_2607.pdf

Questions were asked and answered.

IMAT Reminder:

10:26 a.m. Chair reminded the room that this meeting required registration and payment of registration fee.

Chair asked that eligible participants should sign in to IMAT to claim Working Group attendance credit. He noted that participants not eligible to sign in to IMAT to claim Working Group attendance credit are to send an email to John D'Ambrosia / Kent Lusted to be recorded in the meeting minutes. He paused for a minute to let eligible attendees sign into IMAT. He asked if there was any eligible participant having a problem signing into IMAT. No one responded.

Straw Poll #TF-8

(see comment #R1-140)

Chair noted that motions would be taken with the Direct Vote Live tool if there was not unanimous consent. Chair asked if there would be opposition to attempt the vote by unanimous consent.

There was opposition.

Motion #4:	Move to consider the late presentation daw_02 during the P802.3dj Draft 3.1 comment resolution cycle, if time permits.
Technical (>= 75%)	
Moved by	Matt Brown
Second by	Leon Bruckman
Results 802.3 (y/n/a)	56 / 12 / 6: motion passes 12:10 pm

Motion #4 votes:

Attendee	Vote
Adam Healey	Yes
Adee Ran	No
Ali Ghiasi	Yes
Andras De Koos	Yes
Antonio Tartaglia	Yes
Cathy Liu	Yes
Charles Moorwood	Abstain
Congshi Zou	Abstain
Daniel Estrakh	Abstain
David Estes	Yes
David Lewis	No
David Ofelt	Yes
Elizabeth Kochuparambil	No
Eric Kimber	Yes
Eric Maniloff	Yes
Eugene Opsasnick	Yes
Eyal Lieder	Yes
Flavio Marques	No
Gary Nicholl	Yes

Attendee	Vote
Golam Choudhury	Yes
Gumersindo Veloso Cauce	Abstain
Hansel Dsilva	Yes
Hormoz Djahanshahi	Yes
James Theodoras	Yes
Jane Lim	Abstain
John Johnson	No
Jose Galan	No
Kambiz Vakilian	Yes
Leesa Noujeim	Yes
Leon Bruckman	Yes
Luz Osorio	No
Manabu Kagami	Yes
Marco Mascitto	No
Mark Nowell	No
Mark Sikkink	Yes
Matthew Brown	No
Michael Dudek	Yes
Michael Ransford	No
Mike-Peng Li	Yes
Mohammad Shakiba	Yes
Nathan Tracy	Yes
Norman Swenson	Yes
Pei-Rong Li	Yes
Peter Wu	Yes

Attendee	Vote
Piers J G Dawe	Yes
Pirooz Tooyserkani	Yes
Ramana Murty	Yes
Raymond Nering	Yes
Richard Mellitz	Abstain
Rick Rabinovich	Yes
Sebastien Gareau	Yes
Shawn Nicholl	Yes
Shimon Muller	Yes
Stephane Lessard	Yes
Sylvanus Lee	Yes
Taiji Kondo	Yes
Thomas Huber	Yes
Tj Houck	Yes
Tomoo Takahara	Yes
Toshiaki Sakai	Yes
Vincent Ferretti	Yes
Wenxiong Xu	No
William Simms	Yes
Xiang He	Yes
Xuebo Wang	Yes
Yan Zhuang	Yes
Yasuhiro Hyakutake	Yes
Yuki Murakami	Yes
Yung Sung Son	Yes

Attendee	Vote
Jeff Maki	Yes
Jim Weaver	Yes
Eric Bernier	Yes
Thomas Hogenmueller	Yes

Lunch Break

Break at 12:10 p.m. Resumed at 1:31 p.m.

Chair reviewed the plans for the remainder of the day and for Thursday. He noted that there was offline consensus building on the APSU topics and participants should contact the proponents to get involved.

Chair noted that Thursday would be held exclusively for the APSU topics and closing business. The TF still had late presentations.

Straw Poll TF-8

(see comment R1-274)

Piers Dawe withdrew comment R1-296.

Straw Poll TF-9

(see comment database)

Straw Poll TF-10

(see comment R1-298)

IMAT Reminder:

2:09 p.m. Chair reminded the room that this meeting required registration and payment of registration fee.

Chair asked that eligible participants should sign in to IMAT to claim Working Group attendance credit. He noted that participants not eligible to sign in to IMAT to claim Working Group attendance credit are to send an email to John D'Ambrosia / Kent Lusted to be recorded in the meeting minutes. He paused for a minute to let eligible attendees sign into IMAT. He asked if there was any eligible participant having a problem signing into IMAT. No one responded.

Presentation #TF-5:

Title	Stressed receiver sensitivity setup and calibration
Presenters	Piers Dawe
URL	https://www.ieee802.org/3/dj/public/26_07/dawe_3dj_02_2607.pdf

Questions were asked and answered.

PM Break

Break at 3:17 p.m. Resumed at 3:41 p.m.

IMAT Reminder:

3:58 p.m. Chair reminded the room that this meeting required registration and payment of registration fee.

Chair asked that eligible participants should sign in to IMAT to claim Working Group attendance credit. He noted that participants not eligible to sign in to IMAT to claim Working Group attendance credit are to send an email to John D'Ambrosia / Kent Lusted to be recorded in the meeting minutes. He paused for a minute to let eligible attendees sign into IMAT. He asked if there was any eligible participant having a problem signing into IMAT. No one responded.

Meeting recessed for the day at 4:27 p.m. EDT.

16 July 2026 – Task Force

Session called to order at 8:09 a.m. EDT by John D'Ambrosia , Chair of the P802.3dj Task Force.

Chair noted that every attendee at the IEEE 802.3 Plenary meeting (Face-to-Face or Remote) must register and pay a fee to participate. (see slide #1 of agenda)

Chair reminded participants to declare their name and affiliation in the online meeting tool. Failure to declare would result in expulsion from the meeting.

All participants in IEEE-SA activities are expected to adhere to the core principles underlying the:

- IEEE Code of Ethics
- IEEE Code of Conduct

Chair reminded participants to adhere to decorum. (see agenda slide #8)

Presentation #TF-6:

Title	Consensus proposal for RTS FSM for coherent PMDs
Presenters	Tom Huber
URL	https://www.ieee802.org/3/dj/public/26_07/huber_3dj_02a_2607.pdf

Questions were asked and answered. Gary Nicholl requested to be added as a supporter.

Chair noted that he received notification from Norm Swenson and Hansel D'Silva about an error in the chayeb_3dj_01_2607 presentation with a mathematical sign in an equation. (see:https://www.ieee802.org/3/dj/public/26_07/chayeb_3dj_01_2607.pdf) Norm and Hansel confirmed with the author that the error was true. Chair noted that there was strong interest in fixing the error in the next draft. Chief editor proposed that the corrected equation be added to the editorial slides and the closed comment be reopened to add the reference. Chair asked if there was objection to the approach outlined and noted that the comment would be opened only for the purpose of adding a reference to the corrected equation. He asked if there was opposition to the approach. No one responded.

Chair noted that presentation ran_3dj_05_2607 was directed by the CRG leadership to develop a consensus presentation for TF consideration on Thursday.

Presentation #TF-7:

Title	Consensus proposal for resolving comment #188
Presenters	Adee Ran
URL	https://www.ieee802.org/3/dj/public/26_07/ran_3dj_05a_2607.pdf

Questions were asked and answered. Author noted that on slide 7 local_rx_ready between SEND_LOCAL and RX_READY should be highlighted and would provide an updated 05a. Xuebo Wang offered his support to the contribution. Matt Brown offered his support.

IMAT Reminder - AM:

9:24 a.m. Chair asked that eligible participants should sign in to IMAT to claim Working Group attendance credit. He noted that participants not eligible to sign in to IMAT to claim Working Group attendance credit are to send an email to John D'Ambrosia / Kent Lusted to be recorded in the meeting minutes. He paused for a minute to let eligible attendees sign into IMAT. He asked if there was any eligible participant having a problem signing into IMAT. No one responded.

Chief Editor noted that the response to closed comment #103 needed a correction to the equations referenced in the chayeb_3dj_01_2607.pdf contribution. The new equation replaces the equation on slide 27 of https://www.ieee802.org/3/dj/public/26_07/issenhuth_3dj_01b_2607.pdf He asked if there was objection to reopening comment #103 to make the change. No one responded. The comment was opened, revised, and closed.

Chief Editor noted that all comments were resolved.

Comment resolution completed at 9:37 a.m.

John D'Ambrosia resumed the meeting chair responsibilities at 9:38 a.m.

Chair thanked Kent Lusted and Matt Brown for leading comment resolution. Chair thanked the editorial team and leaders for their hard work during comment resolution.

Chair noted that motions would be taken with the Direct Vote Live tool if there was not unanimous consent. Chair asked if there would be opposition to attempt the vote by unanimous consent.

Motion #5:	Move that the IEEE P802.3dj Task Force • Approves responses to closed comments • Approves generation of D3.2 from D3.1 and approved responses to closed comments
Technical (>= 75%)	
Moved by	Matt Brown
Second by	Adee Ran
Results 802.3 (y/n/a)	Passed by unanimous consent. 9:43 a.m.

Chair noted that closed comments also includes the comments in bucket1 adopted by Motion #1 on Monday, 13 July 2026. The closed comments also include the non-ballot (late) comments from Adee Ran.

Chair reviewed the path going forward and the estimated recirculation ballot dates. (see agenda slide 30 and 31)

Chair reviewed the future meetings and ad hocs in the agenda.

Chair noted that the contingent meetings on 21-23 July were cancelled.

Chair noted that the agenda was complete.

Motion to adjourn

M: Adee Ran

S: Dave Ofelt

Procedural (>50%)

Passed by unanimous consent. 9:53 a.m.

Meeting adjourned at 9:53 a.m.

Attendees (per IMAT)

Note: the Task Force attendance records below capture individuals that registered their attendance via IMAT for one or more “slots” on the specified day

13 July Interim

Name	Employer	Affiliation
Abramczyk, Jaroslaw		Coherent
Akinwale, Oluwafemi	Intel Corporation	Intel Corporation
Alloin, Laurent		Ciena Corporation
Baek, Brian		Apple Inc.
Ben-Artzi, Liav	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
Bernier, Eric	Huawei Technologies Canada Co., Ltd.	Huawei Technologies Canada Co., Ltd.
Brooks, Paul	Viavi solutions GmbH	Viavi Solutions
Bruckman, Leon	NVIDIA	NVIDIA
Calvin, John	Keysight Technologies	Keysight Technologies
Chang, Yongmao	Inphi Corporation	Source Photonics
Chen, Chan	Self Employed	Independent/AOI
cheng, xiaoyue		Infineon Technologies
Choudhury, Golam	Genuine Optics	Genuine Optics
Chow, Kai Soon		Apple Inc.
D'Ambrosia, John	Futurewei Technologies, U.S. Subsidiary of Huawei	Futurewei Technologies, U.S. Subsidiary of Huawei
Dai, Shaoan		Infineon Technologies
Dar, Marva	TE Connectivity	TE Connectivity
Dawe, Piers J G	NVIDIA	Nvidia
de Koos, Andras	Microchip Technology Inc	Microchip Technology Inc
Djahanshahi, Hormoz	Microchip Technology, Inc.	Microchip Technology, Inc.

Name	Employer	Affiliation
Dsilva, Hansel		Amphenol Corporation
Dudek, Michael	Marvell	Marvell
Galan, Jose	MaxLinear, Inc.	MaxLinear, Inc.
Gareau, Sebastien		Ciena Corporation
Geng, Limin	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Ghiasi, Ali	Ghiasi Quantum LLC	Ghiasi Quantum LLC; Marvell Semiconductor, Inc.
Goto, Hideki	Toyota Motor Corporation	Toyota Motor Corporation
Hamilton, Mark	Cadence Design Systems	Cadence Design Systems
Han, Ruibo	China Mobile Communications Corporation (CMCC)	China Mobile Communications Corporation (CMCC)
Hand, Steven		Nokia
HE, MICHAEL	TeraHop Pte. Ltd.	TeraHop Pte. Ltd.
He, Xiang	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Heck, Howard	TE Connectivity	TE Connectivity
Helely, Oren		Marvell Semiconductor, Inc.
Hiroaki, Kukita	Yamaichi Electronics	Yamaichi Electronics
Huang, Kechao	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Huber, Thomas	Nokia	Nokia
Isono, Hideki	Furukawa FITEL Optical Components Limited	Furukawa FITEL Optical Components
Issenhuth, Tom	Issenhuth Consulting, LLC	Huawei Technologies Co., Ltd
Iwasaki, Yutaka	Hirose Electric Co.,Ltd.	Hirose Electric Co., Ltd.
Jackson, Kenneth	Sumitomo Electric Industries, LTD	Sumitomo Electric Industries, LTD
Jin, Robert	Montage Technology, Inc	Montage Technology
Johnson, John	Broadcom Corporation	Broadcom Corporation
Kabra, Lokesh	Synopsys, Inc.	Synopsys, Inc.

Name	Employer	Affiliation
Kareti, Upen	Cisco Systems, Inc.	Cisco Systems, Inc.
KATO, TAKAHIRTO	Dexerials	Dexerials
Kim, DoKyun	LG ELECTRONICS	LG ELECTRONICS
Kim, Gyudong	Analog Devices Inc.	Analog Devices Inc.
Kimber, Eric	Semtech Ltd	Semtech Ltd
Kocsis, Sam	Amphenol Corporation	Amphenol Corporation
Kondo, Taiji	Dexerials Corporation	Dexerials Corporation
Kota, Kishore	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
Kotani, Yasuhiro	DENSO	DENSO
Kutscher, Noam	Marvell Semiconductor, Inc.	Marvell
Landry, Gary	Coherent Corp.	Coherent
Lee, Sylvanus	Leviton Manufacturing Co.	Leviton Manufacturing Co.
Lessard, Stephane	Ericsson AB	Ericsson AB
Lewis, David	SPECIPHY / Lumentum	SPECIPHY, LUMENTUM
Li, Jing	YOFC	YOFC
Li, Mike-Peng	Altera Corporation	Intel Corporation
Li, Pei-Rong	MediaTek Inc.	MediaTek Inc.
Lieder, Eyal	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
Lim, Jane	Cisco Systems, Inc.	Cisco Systems, Inc.
Little, Terrance	Foxconn Electronics Inc.	Foxconn Electronics Inc.
Liu, Cathy	Broadcom Corporation	Broadcom Corporation
Iu, chao	BMW Group	BMW Group
Lusted, Kent	Synopsys, Inc.	Synopsys, Inc.
Maguire, Valerie	Copperopolis	Copperopolis (aff'l with CME Consulting, Cisco, Dell, Microchip, and NXP)

Name	Employer	Affiliation
Maki, Jeffery	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Maniloff, Eric	Ciena Corporation	Ciena Corporation
Marques, Flavio	Lightera	Lightera
Mascitto, Marco	Nokia Canada Inc.	Nokia
Matuz, Balazs		Huawei Technologies Duesseldorf GmbH
Mazzini, Marco	Cisco Systems, Inc.	Cisco Systems, Inc.
Mecklenburg, Ben		Huawei Technologies Duesseldorf GmbH
Mellitz, Richard	Samtec, Inc.	Samtec, Inc.
mi, guangcan	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Moorwood, Charles	Keysight Technologies	Keysight Technologies
Muller, Shimon	Enfabrica Corp.	Enfabrica
MURAKAMI, YUKI	1Finity	1Finity
Murty, Ramana	Broadcom Inc.	Broadcom Corporation
Muth, Karlheinz	Broadcom Corporation	Broadcom Corporation
Nicholl, Shawn	Advanced Micro Devices (AMD)	Advanced Micro Devices (AMD)
NIIHARA, YOSHIHIRO	Fujikura Ltd.	Fujikura Ltd.
Ninomiya, Tiger	Accelink USA Corporation	Accelink USA Corporation
Nowell, Mark	Cisco Systems, Inc.	Cisco Systems, Inc.
Ofelt, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Omori, Kumi	NEC Corporation	NEC Corporation
Opsasnick, Eugene	Broadcom Inc.	Broadcom Inc.
Osorio, Luz	Nokia Canada Inc.	Nokia
Palkert, Thomas	Samtec, Inc.	Samtec, Inc.
Parsons, Earl	CommScope Amphenol	CommScope, Inc.
Parthasarathy, Vasu	Broadcom Corporation	Broadcom Corporation

Name	Employer	Affiliation
Perez De Aranda Alonso, Ruben	Knowledge Development for POF SL	Cisco Systems, Inc.
Rabinovich, Rick	Keysight Technologies	Keysight Technologies
Rajagopal, Karthik	Texas Instruments Inc.	Texas Instruments Inc.
Ran, Adee	Cisco Systems, Inc.	Cisco Systems, Inc.
Ransford, Michael		Corning Incorporated
Razavi, Alireza	Marvell	Infineon Technologies
Ren, Hao	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Rysin, Alexander	NVIDIA	NVIDIA
Sakai, Toshiaki	Socionext Inc.	socionext
Shakiba, Mohammad	Huawei Technologies Canada Co., Ltd.	Huawei Technologies Canada; Huawei Technologies Co., Ltd
Shiino, Masato	FURUKAWA ELECTRIC	FURUKAWA ELECTRIC
Shoval, Ayal	Synopsys, Inc.	Synopsys, Inc.
Shukla, Priyank	Synopsys, Inc.	Synopsys, Inc.
Sikkink, Mark	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Simms, William	NVIDIA Corporation	NVIDIA Corporation
Slavick, Jeff	Broadcom Inc	Broadcom Inc
Sommers, Scott	Molex LLC	Molex Incorporated
Son, Yung Sung	Optomind Inc	Optomind Inc
Srivastava, Atul	NEL-America	NTT Electronics
Sun, Wensheng	Credo Semiconductor	Marvell Semiconductor, Inc.
Sun, Yi	Lightera	Lightera
Swenson, Norman	Norman Swenson Consulting	Norman Swenson Consulting; Point2 Technology Inc.; Nokia
TAKAHARA, TOMOO	FUJITSU LABORATORIES LIMITED	1FINITY

Name	Employer	Affiliation
Tanc, Ahmet		NXP Semiconductors; NXP Semiconductors
Tartaglia, Antonio	Ericsson AB	Ericsson AB
Tooyserkani, Pirooz	Cisco Systems, Inc.	Cisco Systems, Inc.
Torres, Luisma	Knowledge Development for POF SL	KD
Tracy, Nathan	TE Connectivity	TE Connectivity
Tran, Viet	Keysight Technologies	Keysight Technologies
van Dyck, Peter	Infineon Technologies	Infineon Technologies
Venkataraman, Srinivas	Broadcom Corporation	Broadcom Corporation
Wang, Haojie	China Mobile Communications Corporation (CMCC)	China Mobile Communications Corporation (CMCC)
Wang, Xiaofeng	Qualcomm Incorporated	Qualcomm Incorporated
WANG, Xuebo	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Wang, Yutao		Rockwell Automation
Weaver, James	Arista Networks	Arista Networks
Wei, Terry		Analog Devices Inc.
Welch, Brian	Cisco Systems, Inc.	Luxtera
Wig, Timothy	Samtec, Inc.	Samtec, Inc.
Wingrove, Michael	Ciena Corporation	Ciena Corporation
Wu, Dance	Infineon Technologies	Infineon Technologies
Wu, Peter	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
XU, LI	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
xu, wenxiong	HG Genuine	HGGenuine
Xu, Yu	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Yamazaki, Kinya	APRESIA Systems	APRESIA Systems
YANG, Yumeng	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd

Name	Employer	Affiliation
Zhang, Tingting	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
ZHU, YUE		Huawei Technologies Co., Ltd
Zhuang, Shu		Anritsu Company
Zhuang, Yan	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Zou, Congshi	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd

13 July Task Force

Name	Employer	Affiliation
Abramczyk, Jaroslaw		Coherent
Akinwale, Oluwafemi	Intel Corporation	Intel Corporation
Ben-Artzi, Liav	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
Brooks, Paul	Viavi solutions GmbH	Viavi Solutions
Bruckman, Leon	NVIDIA	NVIDIA
Calvin, John	Keysight Technologies	Keysight Technologies
Chang, Yongmao	Inphi Corporation	Source Photonics
Chow, Kai Soon		Apple Inc.
D'Ambrosia, John	Futurewei Technologies, U.S. Subsidiary of Huawei	Futurewei Technologies, U.S. Subsidiary of Huawei
Dar, Marva	TE Connectivity	TE Connectivity
de Koos, Andras	Microchip Technology Inc	Microchip Technology Inc
Djahanshahi, Hormoz	Microchip Technology, Inc.	Microchip Technology, Inc.
Dsilva, Hansel		Amphenol Corporation
Dudek, Michael	Marvell	Marvell
Estes, David	Spirent Communications	VIAVI Solutions

Name	Employer	Affiliation
Galan, Jose	MaxLinear, Inc.	MaxLinear, Inc.
Gareau, Sebastien		Ciena Corporation
Hamilton, Mark	Cadence Design Systems	Cadence Design Systems
Han, Ruibo	China Mobile Communications Corporation (CMCC)	China Mobile Communications Corporation (CMCC)
Hand, Steven		Nokia
He, Xiang	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Healey, Adam	Broadcom Inc.	Broadcom Inc.
Heck, Howard	TE Connectivity	TE Connectivity
Helely, Oren		Marvell Semiconductor, Inc.
Hiroaki, Kukita	Yamaichi Electronics	Yamaichi Electronics
Holdrege, Matthew	Microchip Technology, Inc.	Microchip Technology, Inc.
Huang, Kechao	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Huber, Thomas	Nokia	Nokia
Isono, Hideki	Furukawa FITEL Optical Components Limited	Furukawa FITEL Optical Components
Iwasaki, Yutaka	Hirose Electric Co.,Ltd.	Hirose Electric Co., Ltd.
Jin, Robert	Montage Technology, Inc	Montage Technology
Kareti, Upen	Cisco Systems, Inc.	Cisco Systems, Inc.
KATO, TAKAHIRTO	Dexerials	Dexerials
Kochuparambil, Elizabeth	Cisco Systems, Inc.	Cisco Systems, Inc.
Kocsis, Sam	Amphenol Corporation	Amphenol Corporation
Kondo, Taiji	Dexerials Corporation	Dexerials Corporation
Kutscher, Noam	Marvell Semiconductor, Inc.	Marvell
Lessard, Stephane	Ericsson AB	Ericsson AB

Name	Employer	Affiliation
Li, Mike-Peng	Altera Corporation	Intel Corporation
Li, Pei-Rong	MediaTek Inc.	MediaTek Inc.
Lieder, Eyal	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
Lim, Jane	Cisco Systems, Inc.	Cisco Systems, Inc.
Little, Terrance	Foxconn Electronics Inc.	Foxconn Electronics Inc.
Liu, Cathy	Broadcom Corporation	Broadcom Corporation
Maniloff, Eric	Ciena Corporation	Ciena Corporation
Mascitto, Marco	Nokia Canada Inc.	Nokia
Matuz, Balazs		Huawei Technologies Duesseldorf GmbH
Mazzini, Marco	Cisco Systems, Inc.	Cisco Systems, Inc.
Mellitz, Richard	Samtec, Inc.	Samtec, Inc.
Moorwood, Charles	Keysight Technologies	Keysight Technologies
Muller, Shimon	Enfabrica Corp.	Enfabrica
MURAKAMI, YUKI	1Finity	1Finity
Muth, Karlheinz	Broadcom Corporation	Broadcom Corporation
Nicholl, Shawn	Advanced Micro Devices (AMD)	Advanced Micro Devices (AMD)
Nowell, Mark	Cisco Systems, Inc.	Cisco Systems, Inc.
Nowroozi, Bijan	Lightmatter	Lightmatter
Ofelt, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Oishi, Eiichiro		Yazaki Corporation
Omori, Kumi	NEC Corporation	NEC Corporation
Opsasnick, Eugene	Broadcom Inc.	Broadcom Inc.
Osorio, Luz	Nokia Canada Inc.	Nokia
Palkert, Thomas	Samtec, Inc.	Samtec, Inc.
Parthasarathy, Vasu	Broadcom Corporation	Broadcom Corporation

Name	Employer	Affiliation
Pepper, Gerald	Keysight Technologies	Keysight Technologies
Perez De Aranda Alonso, Ruben	Knowledge Development for POF SL	Cisco Systems, Inc.
Rabinovich, Rick	Keysight Technologies	Keysight Technologies
Ran, Adee	Cisco Systems, Inc.	Cisco Systems, Inc.
Ren, Hao	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Rysin, Alexander	NVIDIA	NVIDIA
Sakai, Toshiaki	Socionext Inc.	socionext
Savi, Olindo	Hubbell Incorporated	Hubbell Incorporated
Shah, Anup	Siemens Corporation	Siemens EDA
Shakiba, Mohammad	Huawei Technologies Canada Co., Ltd.	Huawei Technologies Canada; Huawei Technologies Co., Ltd
Shoval, Ayal	Synopsys, Inc.	Synopsys, Inc.
Shrikhande, Kapil	Marvell Semiconductor, Inc.	Upscale AI
Shukla, Priyank	Synopsys, Inc.	Synopsys, Inc.
Sikkink, Mark	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Simms, William	NVIDIA Corporation	NVIDIA Corporation
Slavick, Jeff	Broadcom Inc	Broadcom Inc
Sommers, Scott	Molex LLC	Molex Incorporated
Sorbara, Massimo	GLOBALFOUNDRIES	GLOBALFOUNDRIES
Srivastava, Atul	NEL-America	NTT Electronics
Sun, Wensheng	Credo Semiconductor	Marvell Semiconductor, Inc.
TAKAHARA, TOMOO	FUJITSU LABORATORIES LIMITED	1FINITY
Tan, Kan	Tektronix, Inc.	Tektronix, Inc.
Tartaglia, Antonio	Ericsson AB	Ericsson AB
Theodoras, James	Scintil Photonics	Scintil Photonics

Name	Employer	Affiliation
Tooyserkani, Pirooz	Cisco Systems, Inc.	Cisco Systems, Inc.
Tracy, Nathan	TE Connectivity	TE Connectivity
Tran, Viet	Keysight Technologies	Keysight Technologies
Venkataraman, Srinivas	Broadcom Corporation	Broadcom Corporation
Wang, Tongtong	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
WANG, Xuebo	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Watanabe, Yojiro	Mitsubishi Electric US, Inc.	Mitsubishi Electric US, Inc.
Weaver, James	Arista Networks	Arista Networks
Welch, Brian	Cisco Systems, Inc.	Luxtera
Wig, Timothy	Samtec, Inc.	Samtec, Inc.
Wingrove, Michael	Ciena Corporation	Ciena Corporation
Wu, Peter	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
Yamazaki, Kinya	APRESIA Systems	APRESIA Systems
Yin, Shuang		Google
Zhuang, Yan	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Zou, Congshi	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Lusted, Kent	Synopsys, Inc.	Synopsys, Inc.
Nicholl, Gary	Cisco Systems, Inc.	Cisco Systems, Inc.
Nowell, Mark	Cisco Systems, Inc.	Cisco Systems, Inc.
Brown, Matthew	Alphawave Semi	Qualcomm

14 July Electrical

Name	Employer	Affiliation
Akinwale, Oluwafemi	Intel Corporation	Intel Corporation

Name	Employer	Affiliation
Bar-Niv, Amir	Aquantia Corp	Infineon Technologies
Ben-Artzi, Liav	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
Benyamin, Saied	Ethernovia	Ethernovia
Brillhart, Theodore	Fluke Corporation	Fluke Corporation
Calvin, John	Keysight Technologies	Keysight Technologies
cheng, xiaoyue		Infineon Technologies
Chow, Kai Soon		Apple Inc.
Dai, Shaoan		Infineon Technologies
Dar, Marva	TE Connectivity	TE Connectivity
Donahue, Curtis	Rohde & Schwarz	Rohde & Schwarz
Dsilva, Hansel		Amphenol Corporation
Dudek, Michael	Marvell	Marvell
Edele, Jonas		BMW AG; BMW Group
Estrakh, Daniel	Valens Semiconductor	Valens Semiconductor
Fuller, Paul		Infineon Technologies
Geng, Limin	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Gilb, James	General Atomics Aeronautical Systems, Inc.	General Atomics Aeronautical Systems, Inc.
Goel, Sachin	Aviva Links Inc	NXP
Han, Ruibo	China Mobile Communications Corporation (CMCC)	China Mobile Communications Corporation (CMCC)
Hand, Steven		Nokia
HE, MICHAEL	TeraHop Pte. Ltd.	TeraHop Pte. Ltd.
Healey, Adam	Broadcom Inc.	Broadcom Inc.
Heck, Howard	TE Connectivity	TE Connectivity
Helely, Oren		Marvell Semiconductor, Inc.
Hiroaki, Kukita	Yamaichi Electronics	Yamaichi Electronics
Irwin, Scott	MoSys, Inc.	ADTRAN Inc.
Iwasaki, Yutaka	Hirose Electric Co.,Ltd.	Hirose Electric Co., Ltd.
Jeffreis, Brad		Analog Devices Inc.
Jin, Robert	Montage Technology, Inc	Montage Technology
Jonsson, Ragnar	Marvell Semiconductor, Inc.	Marvell

Name	Employer	Affiliation
Kandarpa, Venkata	NXP Semiconductors	NXP Semiconductors
Kapoor, Samay	Aviva Links	Aviva Links Inc.
Kareti, Upen	Cisco Systems, Inc.	Cisco Systems, Inc.
Kochuparambil, Elizabeth	Cisco Systems, Inc.	Cisco Systems, Inc.
Kocsis, Sam	Amphenol Corporation	Amphenol Corporation
Kotani, Yasuhiro	DENSO	DENSO
Kutscher, Noam	Marvell Semiconductor, Inc.	Marvell
Lee, Ching-Yen		Realtek Semiconductor Corp.
Li, Mike-Peng	Altera Corporation	Intel Corporation
Li, Pei-Rong	MediaTek Inc.	MediaTek Inc.
Lim, Hoei	NXP Semiconductors	NXP Semiconductors
Lim, Jane	Cisco Systems, Inc.	Cisco Systems, Inc.
Lin, YK	Realtek Semiconductor Corp.	Realtek Semiconductor Corp.
Little, Terrance	Foxconn Electronics Inc.	Foxconn Electronics Inc.
Liu, Cathy	Broadcom Corporation	Broadcom Corporation
Lo, William	Axonne Inc.	Axonne Inc.
Long, Richard	TE Connectivity	TE Connectivity
Lusted, Kent	Synopsys, Inc.	Synopsys, Inc.
Lyu, Yunping(Lily)	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Maniloff, Eric	Ciena Corporation	Ciena Corporation
Mellitz, Richard	Samtec, Inc.	Samtec, Inc.
Miskho, Michael		Analog Devices Inc.
MURAKAMI, YUKI	1Finity	1Finity
Muth, Karlheinz	Broadcom Corporation	Broadcom Corporation
NIIHARA, YOSHIHIRO	Fujikura Ltd.	Fujikura Ltd.
Noujeim, Leesa	Google	Google
Osorio, Luz	Nokia Canada Inc.	Nokia
Pal, Debajyoti		ON Semiconductor
Palkert, Thomas	Samtec, Inc.	Samtec, Inc.
Parthasarathy, Vasu	Broadcom Corporation	Broadcom Corporation
Rabinovich, Rick	Keysight Technologies	Keysight Technologies
Ran, Adee	Cisco Systems, Inc.	Cisco Systems, Inc.

Name	Employer	Affiliation
Razavi, Alireza	Marvell	Eliyan
Rysin, Alexander	NVIDIA	NVIDIA
Sakai, Toshiaki	Socionext Inc.	socionext
Savi, Olindo	Hubbell Incorporated	Hubbell Incorporated
Schedl, Anton	BMW Group	BMW Group
Sedarat, Hossein	Ethernovia	Ethernovia
Shakiba, Mohammad	Huawei Technologies Canada Co., Ltd.	Huawei Technologies Canada; Huawei Technologies Co., Ltd
Sharon, Ari		Terawand
Shoval, Ayal	Synopsys, Inc.	Synopsys, Inc.
Shukla, Priyank	Synopsys, Inc.	Synopsys, Inc.
Simms, William	NVIDIA Corporation	NVIDIA Corporation
sisk, jason	University of New Hampshire InterOperability Laboratory (UNH-IOL)	University of New Hampshire InterOperability Laboratory (UNH-IOL)
Sommers, Scott	Molex LLC	Molex Incorporated
Stencel, Leonard		TDK Corporation of America
Sun, Wensheng	Credo Semiconductor	Credo Semiconductor
TAKEUCHI, JUNICHI	JAE Electronics, Inc	JAE Electronics, Inc.
Tan, Kan	Tektronix, Inc.	Tektronix, Inc.
Tanc, Ahmet		NXP Semiconductors; NXP Semiconductors
Theodoras, James	Scintil Photonics	Scintil Photonics
Tooyserkani, Pirooz	Cisco Systems, Inc.	Cisco Systems, Inc.
Tracy, Nathan	TE Connectivity	TE Connectivity
Vakilian, Kambiz	Broadcom Corporation	Broadcom Corporation
Venkataraman, Srinivas	Broadcom Corporation	Broadcom Corporation
Voss, Robert	Panduit	Panduit Corp.
Wang, Shun-Sheng	Realtek Semiconductor Corp.	Realtek Semiconductor Corp.
Weaver, James	Arista Networks	Arista Networks
Wig, Timothy	Samtec, Inc.	Samtec, Inc.
Wingrove, Michael	Ciena Corporation	Ciena Corporation
Wu, Peter	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
XU, LI	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd

Name	Employer	Affiliation
Xu, Yu	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
YANG, Yumeng	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Zerna, Conrad	Aviva Links Inc	NXP Semiconductors
Zhang, Wei		Broadcom Corporation
Zhuang, Shu		Anritsu Company
Zou, Congshi	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd

14 July Logic

Name	Employer	Affiliation
Abraham, Shiju		Acsia Technologies
Bruckman, Leon	NVIDIA	NVIDIA
Budweiser, Karl		BMW AG; BMW Group
Chidambaram, Valliaappan		Acsia Technologies
de Koos, Andras	Microchip Technology Inc	Microchip Technology Inc
Estes, David	Spirent Communications	VIAVI Solutions
Gareau, Sebastien		Ciena Corporation
Gorshe, Steven Scott	Microchip Technology, Inc.	Microchip Technology, Inc.
Hameed, Anil		Acsia Technologies
Hamilton, Mark	Cadence Design Systems	Cadence Design Systems
Hand, Steven		Nokia
He, Xiang	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Holdrege, Matthew	Microchip Technology, Inc.	Microchip Technology, Inc.
Huang, Kechao	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Huber, Thomas	Nokia	Nokia
Joseph, Gloria		Acsia Technologies
Kim, DoKyun	LG ELECTRONICS	LG ELECTRONICS
Kleinwaechter, Mathias	in-tech GmbH	in-tech GmbH

Name	Employer	Affiliation
Li, Jieyu		China Mobile Communications Group Co.,Ltd; China Mobile Communications Group Co.,Ltd
Lieder, Eyal	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
Lou, Wei		Broadcom Corporation
Mascitto, Marco	Nokia Canada Inc.	Nokia
Moorwood, Charles	Keysight Technologies	Keysight Technologies
Muller, Shimon	Enfabrica Corp.	Enfabrica
Nicholl, Gary	Cisco Systems, Inc.	Cisco Systems, Inc.
Nicholl, Shawn	Advanced Micro Devices (AMD)	Advanced Micro Devices (AMD)
Ofelt, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Opsasnick, Eugene	Broadcom Inc.	Broadcom Inc.
Parkholm, Ulf	Telefon AB LM Ericsson	Ericsson AB
Pepper, Gerald	Keysight Technologies	Keysight Technologies
Ren, Hao	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Shah, Anup	Siemens Corporation	Siemens EDA
Shrikhande, Kapil	Marvell Semiconductor, Inc.	Upscale AI
Sikkink, Mark	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Slavick, Jeff	Broadcom Inc	Broadcom Inc
Sun, Yi	Lightera	Lightera
Tanz, Simon		BMW AG; BMW Group
Thomas, Rajan		Acsia Technologies
Tran, Viet	Keysight Technologies	Keysight Technologies
van Dyck, Peter	Infineon Technologies	Infineon Technologies
Veloso Cauce, Gumersindo	BMW Group	BMW AG; BMW Group
Wang, Tongtong	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd

Name	Employer	Affiliation
WANG, Xuebo	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Zhuang, Yan	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd

14 July Optical

Name	Employer	Affiliation
Abramczyk, Jaroslaw		Coherent
Akinwale, Oluwafemi	Intel Corporation	Intel Corporation
Alloin, Laurent		Ciena Corporation
Baek, Brian		Apple Inc.
Ben-Artzi, Liav	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
Bernier, Eric	Huawei Technologies Canada Co., Ltd.	Huawei Technologies Canada Co., Ltd.
Brillhart, Theodore	Fluke Corporation	Fluke Corporation
Brooks, Paul	Viavi solutions GmbH	Viavi Solutions
Bruckman, Leon	NVIDIA	NVIDIA
Calvin, John	Keysight Technologies	Keysight Technologies
Castro, Jose	Panduit	Panduit Corp.
Chang, Yongmao	Inphi Corporation	Source Photonics
Chen, Chan	Self Employed	Independent/AOI
Chini, Ahmad	Broadcom Corporation	Broadcom Corporation
Choudhury, Golam	Genuine Optics	Genuine Optics
Cole, Christopher R	Finisar Corporation	Coherent Corp.
D'Ambrosia, John	Futurewei Technologies, U.S. Subsidiary of Huawei	Futurewei Technologies, U.S. Subsidiary of Huawei
Dar, Marva	TE Connectivity	TE Connectivity
Dawe, Piers J G	NVIDIA	Nvidia
Djahanshahi, Hormoz	Microchip Technology, Inc.	Microchip Technology, Inc.
Dsilva, Hansel		Amphenol Corporation
Dudek, Michael	Marvell	Marvell
Engenhardt, Klaus		Teradyne, Inc. & Quantifi Photonics
Estes, David	Spirent Communications	VIAVI Solutions
Ferretti, Vincent	Corning Incorporated	Corning Incorporated
Galan, Jose	MaxLinear, Inc.	MaxLinear, Inc.
Gareau, Sebastien		Ciena Corporation

Name	Employer	Affiliation
Geng, Limin	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Ghiasi, Ali	Ghiasi Quantum LLC	Ghiasi Quantum LLC; Marvell Semiconductor, Inc.
Hamilton, Mark	Cadence Design Systems	Cadence Design Systems
HE, MICHAEL	TeraHop Pte. Ltd.	TeraHop Pte. Ltd.
He, Xiang	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Healey, Adam	Broadcom Inc.	Broadcom Inc.
Hiroaki, Kukita	Yamaichi Electronics	Yamaichi Electronics
Hogenmueller, Thomas	Robert Bosch GmbH	Robert Bosch GmbH
Holdrege, Matthew	Microchip Technology, Inc.	Microchip Technology, Inc.
Huang, Kechao	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Huber, Thomas	Nokia	Nokia
HYAKUTAKE, YASUHIRO	Orbray Co., Ltd.	Orbray Co., Ltd.
Isono, Hideki	Furukawa FITEL Optical Components Limited	Furukawa FITEL Optical Components
Issenhuth, Tom	Issenhuth Consulting, LLC	Huawei Technologies Co., Ltd
Jackson, Kenneth	Sumitomo Electric Industries, LTD	Sumitomo Electric Industries, LTD
Jin, Robert	Montage Technology, Inc	Montage Technology
Johnson, John	Broadcom Corporation	Broadcom Corporation
Kagami, Manabu	Nagoya Institute of Technology	Nagoya Institute of Technology (NITech)
KATO, TAKAHIRO	Dexerials	Dexerials
Kimber, Eric	Semtech Ltd	Semtech Ltd
Kocsis, Sam	Amphenol Corporation	Amphenol Corporation
Kondo, Taiji	Dexerials Corporation	Dexerials Corporation
Kota, Kishore	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
Landry, Gary	Coherent Corp.	Coherent
Lee, Sylvanus	Leviton Manufacturing Co.	Leviton Manufacturing Co.
Lessard, Stephane	Ericsson AB	Ericsson AB

Name	Employer	Affiliation
Lewis, David	SPECIPHY / Lumentum	SPECIPHY, LUMENTUM
Lewis, Jon	Dell Technologies	Dell Technologies
Li, Jing	YOFC	YOFC
Li, Pei-Rong	MediaTek Inc.	MediaTek Inc.
Lieder, Eyal	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
Lim, Jane	Cisco Systems, Inc.	Cisco Systems, Inc.
Little, Terrance	Foxconn Electronics Inc.	Foxconn Electronics Inc.
Liu, Cathy	Broadcom Corporation	Broadcom Corporation
Iu, chao	BMW Group	BMW Group
Lyu, Yunping(Lily)	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Maki, Jeffery	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Maniloff, Eric	Ciena Corporation	Ciena Corporation
Marques, Flavio	Lightera	Lightera
Matuz, Balazs		Huawei Technologies Duesseldorf GmbH
Mazzini, Marco	Cisco Systems, Inc.	Cisco Systems, Inc.
Mecklenburg, Ben		Huawei Technologies Duesseldorf GmbH
Mellitz, Richard	Samtec, Inc.	Samtec, Inc.
mi, guangcan	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Moorwood, Charles	Keysight Technologies	Keysight Technologies
Muller, Shimon	Enfabrica Corp.	Enfabrica
MURAKAMI, YUKI	1Finity	1Finity
Murty, Ramana	Broadcom Inc.	Broadcom Corporation
Muth, Karlheinz	Broadcom Corporation	Broadcom Corporation
Nering, Raymond	Cisco Systems, Inc.	Cisco Systems, Inc.
Nicholl, Gary	Cisco Systems, Inc.	Cisco Systems, Inc.
Nicholl, Shawn	Advanced Micro Devices (AMD)	Advanced Micro Devices (AMD)
Ninomiya, Tiger	Accelink USA Corporation	Accelink / Self
Noujeim, Leesa	Google	Google
Nowell, Mark	Cisco Systems, Inc.	Cisco Systems, Inc.
Nowroozi, Bijan	Lightmatter	Lightmatter
Ofelt, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Omori, Kumi	NEC Corporation	NEC Corporation

Name	Employer	Affiliation
Opsasnick, Eugene	Broadcom Inc.	Broadcom Inc.
Pan, Chunpo		Broadcom Corporation
Parsons, Earl	CommScope Amphenol	CommScope, Inc.
Pepper, Gerald	Keysight Technologies	Keysight Technologies
Perez De Aranda Alonso, Ruben	Knowledge Development for POF SL	Cisco Systems, Inc.
Rabinovich, Rick	Keysight Technologies	Keysight Technologies
Rajagopal, Karthik	Texas Instruments Inc.	Texas Instruments Inc.
Ransford, Michael		Corning Incorporated
Ren, Hao	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Rodes, Roberto	II-VI	II-VI
Rysin, Alexander	NVIDIA	NVIDIA
Sakai, Toshiaki	Socionext Inc.	socionext
Sambasivan, Sam	AT&T	AT&T
Savi, Olindo	Hubbell Incorporated	Hubbell Incorporated
Shah, Anup	Siemens Corporation	Siemens EDA
Shakiba, Mohammad	Huawei Technologies Canada Co., Ltd.	Huawei Technologies Canada; Huawei Technologies Co., Ltd
Sharon, Ari		Terawand
Shoval, Ayal	Synopsys, Inc.	Synopsys, Inc.
Sikkink, Mark	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Simms, William	NVIDIA Corporation	NVIDIA Corporation
Sommers, Scott	Molex LLC	Molex Incorporated
Son, Yung Sung	Optomind Inc	Optomind Inc
Sorbara, Massimo	GLOBALFOUNDRIES	GLOBALFOUNDRIES
Srivastava, Atul	NEL-America	NTT Electronics
Sun, Wensheng	Credo Semiconductor	Credo Semiconductor
Sun, Yi	Lightera	Lightera
Swenson, Norman	Norman Swenson Consulting	Norman Swenson Consulting; Point2 Technology Inc.; Nokia
TAKAHARA, TOMOO	FUJITSU LABORATORIES LIMITED	1FINITY
Tan, Kan	Tektronix, Inc.	Tektronix, Inc.
Tartaglia, Antonio	Ericsson AB	Ericsson AB
Theodoras, James	Scintil Photonics	Scintil Photonics
Tooyserkani, Pirooz	Cisco Systems, Inc.	Cisco Systems, Inc.

Name	Employer	Affiliation
Torres, Luisma	Knowledge Development for POF SL	KD
Wang, Haojie	China Mobile Communications Corporation (CMCC)	China Mobile Communications Corporation (CMCC)
Wang, Tongtong	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Wang, Xiaofeng	Qualcomm Incorporated	Qualcomm Incorporated
WANG, Xuebo	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Watanabe, Yojiro	Mitsubishi Electric US, Inc.	Mitsubishi Electric US, Inc.
Welch, Brian	Cisco Systems, Inc.	Luxtera
XU, LI	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
xu, wenxiong	HG Genuine	HGGenuine
Xu, Yu	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Yamazaki, Kinya	APRESIA Systems	APRESIA Systems
YANG, Yumeng	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Yin, Shuang		Google
Zhuang, Shu		Anritsu Company
Zhuang, Yan	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Brown, Matthew	Alphawave Semi	Qualcomm

15 July Task Force

Name	Employer	Affiliation
D'Ambrosia, John	Futurewei Technologies, U.S. Subsidiary of Huawei	Futurewei Technologies, U.S. Subsidiary of Huawei
Issenhuth, Tom	Issenhuth Consulting, LLC	Huawei Technologies Co., Ltd
Lusted, Kent	Synopsys, Inc.	Synopsys, Inc.
Nicholl, Gary	Cisco Systems, Inc.	Cisco Systems, Inc.
Nowell, Mark	Cisco Systems, Inc.	Cisco Systems, Inc.
Opsasnick, Eugene	Broadcom Inc.	Broadcom Inc.
Ran, Adeel	Cisco Systems, Inc.	Cisco Systems, Inc.
Abramczyk, Jaroslaw		Coherent

Name	Employer	Affiliation
Akinwale, Oluwafemi	Intel Corporation	Intel Corporation
Alloin, Laurent		Ciena Corporation
Baek, Brian		Apple Inc.
Ben-Artzi, Liav	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
Bernier, Eric	Huawei Technologies Canada Co., Ltd.	Huawei Technologies Canada Co., Ltd.
Brillhart, Theodore	Fluke Corporation	Fluke Corporation
Brooks, Paul	Viavi solutions GmbH	Viavi Solutions
Brown, Matthew	Alphawave Semi	Qualcomm
Bruckman, Leon	NVIDIA	NVIDIA
Calvin, John	Keysight Technologies	Keysight Technologies
Castro, Jose	Panduit	Panduit Corp.
Chang, Jae-yong	Keysight Technologies Inc	Keysight Technologies Inc
Chang, Yongmao	Inphi Corporation	Source Photonics
Chen, Chan	Self Employed	Independent/AOI
cheng, xiaoyue		Infineon Technologies
Chimento, Nicholas		Analog Devices Inc.
Choudhury, Golam	Genuine Optics	Genuine Optics
Chow, Kai Soon		Apple Inc.
Chughtai, Muhammad Saad		Tektronix, Inc.
Cole, Christopher R	Finisar Corporation	Coherent Corp.
Dai, Shaoan		Infineon Technologies
Dar, Marva	TE Connectivity	TE Connectivity
Dawe, Piers J G	NVIDIA	Nvidia
de Koos, Andras	Microchip Technology Inc	Microchip Technology Inc
Djahanshahi, Hormoz	Microchip Technology, Inc.	Microchip Technology, Inc.
Dsilva, Hansel		Amphenol Corporation
Dudek, Michael	Marvell	Marvell
Engenhardt, Klaus		Teradyne, Inc. & Quantifi Photonics
Estes, David	Spirent Communications	VIAVI Solutions
Estrakh, Daniel	Valens Semiconductor	Valens Semiconductor
Ferretti, Vincent	Corning Incorporated	Corning Incorporated
Fuller, Paul		Infineon Technologies
Galan, Jose	MaxLinear, Inc.	MaxLinear, Inc.
Gareau, Sebastien		Ciena Corporation

Name	Employer	Affiliation
Gauthier, Claude	NXP Semiconductors	NXP Semiconductors
Geng, Limin	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Ghiasi, Ali	Ghiasi Quantum LLC	Ghiasi Quantum LLC; Marvell Semiconductor, Inc.
Hamilton, Mark	Cadence Design Systems	Cadence Design Systems
Han, Ruibo	China Mobile Communications Corporation (CMCC)	China Mobile Communications Corporation (CMCC)
Hand, Steven		Nokia
HE, MICHAEL	TeraHop Pte. Ltd.	TeraHop Pte. Ltd.
He, Xiang	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Healey, Adam	Broadcom Inc.	Broadcom Inc.
Heck, Howard	TE Connectivity	TE Connectivity
Helely, Oren		Marvell Semiconductor, Inc.
Hiroaki, Kukita	Yamaichi Electronics	Yamaichi Electronics
Hogenmueller, Thomas	Robert Bosch GmbH	Robert Bosch GmbH
Holdrege, Matthew	Microchip Technology, Inc.	Microchip Technology, Inc.
Houck, TJ	Infineon Technologies	Infineon Technologies
Huang, Kechao	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Huber, Thomas	Nokia	Nokia
HYAKUTAKE, YASUHIRO	Orbray Co., Ltd.	Orbray Co., Ltd.
Irwin, Scott	MoSys, Inc.	ADTRAN Inc.
Isono, Hideki	Furukawa FITEL Optical Components Limited	Furukawa FITEL Optical Components
Jackson, Kenneth	Sumitomo Electric Industries, LTD	Sumitomo Electric Industries, LTD
Jin, Robert	Montage Technology, Inc	Montage Technology
Johnson, John	Broadcom Corporation	Broadcom Corporation
Kagami, Manabu	Nagoya Institute of Technology	Nagoya Institute of Technology (NITech)
Kareti, Upen	Cisco Systems, Inc.	Cisco Systems, Inc.
KATO, TAKAHIRO	Dexerials	Dexerials

Name	Employer	Affiliation
Kimber, Eric	Semtech Ltd	Semtech Ltd
Kochuparambil, Elizabeth	Cisco Systems, Inc.	Cisco Systems, Inc.
Kocsis, Sam	Amphenol Corporation	Amphenol Corporation
Kondo, Taiji	Dexerials Corporation	Dexerials Corporation
Kota, Kishore	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
Kotani, Yasuhiro	DENSO	DENSO
Kutscher, Noam	Marvell Semiconductor, Inc.	Marvell
Landry, Gary	Coherent Corp.	Coherent
Lasry, Ariel	Qualcomm Technologies, Inc	Qualcomm Technologies, Inc
Law, Andrew	Student	Self
Lee, Sylvanus	Leviton Manufacturing Co.	Leviton Manufacturing Co.
Lessard, Stephane	Ericsson AB	Ericsson AB
Lewis, David	SPECIPHY / Lumentum	SPECIPHY, LUMENTUM
Lewis, Jon	Dell Technologies	Dell Technologies
Li, Mike-Peng	Altera Corporation	Intel Corporation
Li, Pei-Rong	MediaTek Inc.	MediaTek Inc.
Lieder, Eyal	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
Lim, Hoei	NXP Semiconductors	NXP Semiconductors
Lim, Jane	Cisco Systems, Inc.	Cisco Systems, Inc.
Little, Terrance	Foxconn Electronics Inc.	Foxconn Electronics Inc.
Liu, Cathy	Broadcom Corporation	Broadcom Corporation
Lo, William	Axonne Inc.	Axonne Inc.
Long, Richard	TE Connectivity	TE Connectivity
lu, chao	BMW Group	BMW Group
Lyu, Yunping(Lily)	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Maguire, Valerie	Copperopolis	Copperopolis (aff'l with CME Consulting, Microchip, and NXP)
Maki, Jeffery	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Maniloff, Eric	Ciena Corporation	Ciena Corporation
Marques, Flavio	Lightera	Lightera
Mascitto, Marco	Nokia Canada Inc.	Nokia

Name	Employer	Affiliation
Matuz, Balazs		Huawei Technologies Duesseldorf GmbH
Mazzini, Marco	Cisco Systems, Inc.	Cisco Systems, Inc.
Mecklenburg, Ben		Huawei Technologies Duesseldorf GmbH
Mellitz, Richard	Samtec, Inc.	Samtec, Inc.
mi, guangcan	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Moorwood, Charles	Keysight Technologies	Keysight Technologies
Muller, Shimon	Enfabrica Corp.	Enfabrica
Muma, Scott	Microchip Technology, Inc.	Microchip Technology, Inc.
MURAKAMI, YUKI	1Finity	1Finity
Murty, Ramana	Broadcom Inc.	Broadcom Corporation
Muth, Karlheinz	Broadcom Corporation	Broadcom Corporation
Nering, Raymond	Cisco Systems, Inc.	Cisco Systems, Inc.
Nicholl, Shawn	Advanced Micro Devices (AMD)	Advanced Micro Devices (AMD)
Ninomiya, Tiger	Accelink USA Corporation	Accelink / Self
Noujeim, Leesa	Google	Google
Nowroozi, Bijan	Lightmatter	Lightmatter
Ofelt, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Omori, Kumi	NEC Corporation	NEC Corporation
Osorio, Luz	Nokia Canada Inc.	Nokia
Pal, Debajyoti		ON Semiconductor
Palkert, Thomas	Samtec, Inc.	Samtec, Inc.
Pan, Chunpo		Broadcom Corporation
Parthasarathy, Vasu	Broadcom Corporation	Broadcom Corporation
Pepper, Gerald	Keysight Technologies	Keysight Technologies
Perez De Aranda Alonso, Ruben	Knowledge Development for POF SL	Cisco Systems, Inc.
Rabinovich, Rick	Keysight Technologies	Keysight Technologies
Rajagopal, Karthik	Texas Instruments Inc.	Texas Instruments Inc.
Ransford, Michael		Corning Incorporated
Razavi, Alireza	Marvell	Eliyan
Ren, Hao	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Rodes, Roberto	II-VI	II-VI
Rysin, Alexander	NVIDIA	NVIDIA

Name	Employer	Affiliation
Sakai, Toshiaki	Socionext Inc.	socionext
Sambasivan, Sam	AT&T	AT&T
Savi, Olindo	Hubbell Incorporated	Hubbell Incorporated
Sedarat, Hossein	Ethernovia	Ethernovia
Shah, Anup	Siemens Corporation	Siemens EDA
Shakiba, Mohammad	Huawei Technologies Canada Co., Ltd.	Huawei Technologies Canada; Huawei Technologies Co., Ltd
Sharon, Ari		Terawand
Shoval, Ayal	Synopsys, Inc.	Synopsys, Inc.
Shrikhande, Kapil	Marvell Semiconductor, Inc.	Upscale AI
Shukla, Priyank	Synopsys, Inc.	Synopsys, Inc.
Sikkink, Mark	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Simms, William	NVIDIA Corporation	NVIDIA Corporation
sisk, jason	University of New Hampshire InterOperability Laboratory (UNH-IOL)	University of New Hampshire InterOperability Laboratory (UNH-IOL)
Slavick, Jeff	Broadcom Inc	Broadcom Inc
Sommers, Scott	Molex LLC	Molex Incorporated
Son, Yung Sung	Optomind Inc	Optomind Inc
Sorbara, Massimo	GLOBALFOUNDRIES	GLOBALFOUNDRIES
Srivastava, Atul	NEL-America	NTT Electronics
Sun, Wensheng	Credo Semiconductor	Credo Semiconductor
Swenson, Norman	Norman Swenson Consulting	Norman Swenson Consulting; Point2 Technology Inc.; Nokia
TAKAHARA, TOMOO	FUJITSU LABORATORIES LIMITED	1FINITY
TAKEUCHI, JUNICHI	JAE Electronics, Inc	JAE Electronics, Inc.
Tan, Kan	Tektronix, Inc.	Tektronix, Inc.
Tan, Yuxuan	Motorcomm	Motorcomm
Tartaglia, Antonio	Ericsson AB	Ericsson AB
TAZEBAY, MEHMET	Broadcom Corporation	Broadcom Corporation
Theodoras, James	Scintil Photonics	Scintil Photonics
Tooyserkani, Pirooz	Cisco Systems, Inc.	Cisco Systems, Inc.
Tracy, Nathan	TE Connectivity	TE Connectivity
Tran, Viet	Keysight Technologies	Keysight Technologies
Vakilian, Kambiz	Broadcom Corporation	Broadcom Corporation

Name	Employer	Affiliation
van Dyck, Peter	Infineon Technologies	Infineon Technologies
Veloso Cauce, Gumersindo	BMW Group	BMW AG; BMW Group
Venkataraman, Srinivas	Broadcom Corporation	Broadcom Corporation
Wang, Haojie	China Mobile Communications Corporation (CMCC)	China Mobile Communications Corporation (CMCC)
Wang, Tongtong	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Wang, Xiaofeng	Qualcomm Incorporated	Qualcomm Incorporated
WANG, Xuebo	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Weaver, James	Arista Networks	Arista Networks
Welch, Brian	Cisco Systems, Inc.	Luxtera
Wig, Timothy	Samtec, Inc.	Samtec, Inc.
Wingrove, Michael	Ciena Corporation	Ciena Corporation
Wu, Dance	Infineon Technologies	Infineon Technologies
Wu, Peter	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
XU, LI	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
xu, wenxiong	HG Genuine	HGGenuine
Xu, Yu	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Yamazaki, Kinya	APRESIA Systems	APRESIA Systems
Yin, Shuang		Google
Zhang, Tingting	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Zhuang, Shu		Anritsu Company
Zhuang, Yan	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Zivny, Pavel	Lumilens	Lumilens
Zou, Congshi	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd

16 July Task Force

Name	Employer	Affiliation
D'Ambrosia, John	Futurewei Technologies, U.S. Subsidiary of Huawei	Futurewei Technologies, U.S. Subsidiary of Huawei

Name	Employer	Affiliation
Issenhuth, Tom	Issenhuth Consulting, LLC	Huawei Technologies Co., Ltd
Lusted, Kent	Synopsys, Inc.	Synopsys, Inc.
Nicholl, Gary	Cisco Systems, Inc.	Cisco Systems, Inc.
Nowell, Mark	Cisco Systems, Inc.	Cisco Systems, Inc.
Opsasnick, Eugene	Broadcom Inc.	Broadcom Inc.
Ran, Adeel	Cisco Systems, Inc.	Cisco Systems, Inc.
Abramczyk, Jaroslaw		Coherent
Akinwale, Oluwafemi	Intel Corporation	Intel Corporation
Alloin, Laurent		Ciena Corporation
Baek, Brian		Apple Inc.
Ben-Artzi, Liav	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
Bernier, Eric	Huawei Technologies Canada Co., Ltd.	Huawei Technologies Canada Co., Ltd.
Brooks, Paul	Viavi solutions GmbH	Viavi Solutions
Brown, Matthew	Alphawave Semi	Qualcomm
Bruckman, Leon	NVIDIA	NVIDIA
Calvin, John	Keysight Technologies	Keysight Technologies
Castro, Jose	Panduit	Panduit Corp.
Chang, Yongmao	Inphi Corporation	Source Photonics
Chen, Chan	Self Employed	Independent/AOI
Choudhury, Golam	Genuine Optics	Genuine Optics
Chow, Kai Soon		Apple Inc.
Chughtai, Muhammad Saad		Tektronix, Inc.
Cole, Christopher R	Finisar Corporation	Coherent Corp.
Dar, Marva	TE Connectivity	TE Connectivity
Dawe, Piers J G	NVIDIA	Nvidia
de Koos, Andras	Microchip Technology Inc	Microchip Technology Inc
Dsilva, Hansel		Amphenol Corporation
Dudek, Michael	Marvell	Marvell
Estes, David	Spirent Communications	VIavi Solutions
Galan, Jose	MaxLinear, Inc.	MaxLinear, Inc.
Gareau, Sebastien		Ciena Corporation
Geng, Limin	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Ghiasi, Ali	Ghiasi Quantum LLC	Ghiasi Quantum LLC; Marvell Semiconductor, Inc.

Name	Employer	Affiliation
Hamilton, Mark	Cadence Design Systems	Cadence Design Systems
Han, Ruibo	China Mobile Communications Corporation (CMCC)	China Mobile Communications Corporation (CMCC)
Hand, Steven		Nokia
HE, MICHAEL	TeraHop Pte. Ltd.	TeraHop Pte. Ltd.
He, Xiang	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Heck, Howard	TE Connectivity	TE Connectivity
Helely, Oren		Marvell Semiconductor, Inc.
Hiroaki, Kukita	Yamaichi Electronics	Yamaichi Electronics
Holdrege, Matthew	Microchip Technology, Inc.	Microchip Technology, Inc.
Huang, Kechao	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Huber, Thomas	Nokia	Nokia
Irwin, Scott	MoSys, Inc.	ADTRAN Inc.
Isono, Hideki	Furukawa FITEL Optical Components Limited	Furukawa FITEL Optical Components
Jackson, Kenneth	Sumitomo Electric Industries, LTD	Sumitomo Electric Industries, LTD
Jin, Robert	Montage Technology, Inc	Montage Technology
Johnson, John	Broadcom Corporation	Broadcom Corporation
Kareti, Upen	Cisco Systems, Inc.	Cisco Systems, Inc.
Kimber, Eric	Semtech Ltd	Semtech Ltd
Kocsis, Sam	Amphenol Corporation	Amphenol Corporation
Kondo, Taiji	Dexerials Corporation	Dexerials Corporation
Kota, Kishore	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
Kutscher, Noam	Marvell Semiconductor, Inc.	Marvell
Landry, Gary	Coherent Corp.	Coherent
Lee, Sylvanus	Leviton Manufacturing Co.	Leviton Manufacturing Co.
Lewis, David	SPECIPHY / Lumentum	SPECIPHY, LUMENTUM
Li, Mike-Peng	Altera Corporation	Intel Corporation
Li, Pei-Rong	MediaTek Inc.	MediaTek Inc.

Name	Employer	Affiliation
Lieder, Eyal	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
Lim, Jane	Cisco Systems, Inc.	Cisco Systems, Inc.
Little, Terrance	Foxconn Electronics Inc.	Foxconn Electronics Inc.
Liu, Cathy	Broadcom Corporation	Broadcom Corporation
Maki, Jeffery	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Maniloff, Eric	Ciena Corporation	Ciena Corporation
Marques, Flavio	Lightera	Lightera
Mascitto, Marco	Nokia Canada Inc.	Nokia
Matuz, Balazs		Huawei Technologies Duesseldorf GmbH
Mazzini, Marco	Cisco Systems, Inc.	Cisco Systems, Inc.
mi, guangcan	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Moorwood, Charles	Keysight Technologies	Keysight Technologies
Muller, Shimon	Enfabrica Corp.	Enfabrica
MURAKAMI, YUKI	1Finity	1Finity
Murty, Ramana	Broadcom Inc.	Broadcom Corporation
Muth, Karlheinz	Broadcom Corporation	Broadcom Corporation
Nering, Raymond	Cisco Systems, Inc.	Cisco Systems, Inc.
Nicholl, Shawn	Advanced Micro Devices (AMD)	Advanced Micro Devices (AMD)
Ninomiya, Tiger	Accelink USA Corporation	Accelink / Self
Nowroozi, Bijan	Lightmatter	Lightmatter
Ofelt, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Omori, Kumi	NEC Corporation	NEC Corporation
Osorio, Luz	Nokia Canada Inc.	Nokia
Palkert, Thomas	Samtec, Inc.	Samtec, Inc.
Parsons, Earl	CommScope Amphenol	CommScope, Inc.
Parthasarathy, Vasu	Broadcom Corporation	Broadcom Corporation
Pepper, Gerald	Keysight Technologies	Keysight Technologies
Perez De Aranda Alonso, Ruben	Knowledge Development for POF SL	Cisco Systems, Inc.
Rabinovich, Rick	Keysight Technologies	Keysight Technologies
Ransford, Michael		Corning Incorporated
Ren, Hao	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd

Name	Employer	Affiliation
Rodes, Roberto	II-VI	II-VI
Rysin, Alexander	NVIDIA	NVIDIA
Sakai, Toshiaki	Socionext Inc.	socionext
Sambasivan, Sam	AT&T	AT&T
Savi, Olindo	Hubbell Incorporated	Hubbell Incorporated
Shakiba, Mohammad	Huawei Technologies Canada Co., Ltd.	Huawei Technologies Canada; Huawei Technologies Co., Ltd
Shoval, Ayal	Synopsys, Inc.	Synopsys, Inc.
Shukla, Priyank	Synopsys, Inc.	Synopsys, Inc.
Sikkink, Mark	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Simms, William	NVIDIA Corporation	NVIDIA Corporation
Slavick, Jeff	Broadcom Inc	Broadcom Inc
Sommers, Scott	Molex LLC	Molex Incorporated
Son, Yung Sung	Optomind Inc	Optomind Inc
Sorbara, Massimo	GLOBALFOUNDRIES	GLOBALFOUNDRIES
Sun, Wensheng	Credo Semiconductor	Credo Semiconductor
Sun, Yi	Lightera	Lightera
Swenson, Norman	Norman Swenson Consulting	Norman Swenson Consulting; Point2 Technology Inc.; Nokia
TAKAHARA, TOMOO	FUJITSU LABORATORIES LIMITED	1FINITY
Tartaglia, Antonio	Ericsson AB	Ericsson AB
Theodoras, James	Scintil Photonics	Scintil Photonics
Tooyserkani, Pirooz	Cisco Systems, Inc.	Cisco Systems, Inc.
Tracy, Nathan	TE Connectivity	TE Connectivity
Venkataraman, Srinivas	Broadcom Corporation	Broadcom Corporation
Wang, Haojie	China Mobile Communications Corporation (CMCC)	China Mobile Communications Corporation (CMCC)
Wang, Tongtong	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Wang, Xiaofeng	Qualcomm Incorporated	Qualcomm Incorporated
WANG, Xuebo	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Weaver, James	Arista Networks	Arista Networks
Welch, Brian	Cisco Systems, Inc.	Luxtera
Wig, Timothy	Samtec, Inc.	Samtec, Inc.

Name	Employer	Affiliation
Wingrove, Michael	Ciena Corporation	Ciena Corporation
Wu, Peter	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
XU, LI	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
xu, wenxiong	HG Genuine	HGGenuine
Xu, Yu	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Yamazaki, Kinya	APRESIA Systems	APRESIA Systems
YANG, Yumeng	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Zhuang, Shu		Anritsu Company
Zhuang, Yan	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd
Zivny, Pavel	Lumilens	Lumilens
Zou, Congshi	Huawei Technologies Co., Ltd	Huawei Technologies Co., Ltd